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# RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP: RX62N

DEVICE : R5F562NXXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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# Table. Reliability test results (QFP)

Tubic Remarkly took rooms (4.17)							
Test Items	Test Items Reference Test Conditions		Results Failure/Size	Comment			
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22				
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22				
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22				
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 $^{\circ}$ to 150 $^{\circ}$ , 300 cycles	0/22				
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3				
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2			
Electrostatic discharge (ESD-CDM)	JEITA ED-4701/302	+/-1000V,1time 0/3		Class: Equivalent to C2b			
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5				
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22				

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



# Table. Reliability test results (BGA)

Test Items	Reference Test Conditions		Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ to 125 $^{\circ}$ , 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time 0/3		Class: 2
Electrostatic discharge (ESD-CDM)  JEITA +/-1000V,1time		+/-1000V,1time	0/3	Class: Equivalent to C2b
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3

#### Note:

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>•</sup>It is tested to confirm that all the samples are satisfied with an individual product specification.



# Table. Reliability test results (LGA)

Test Items	Test Items Reference Test Conditions		Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 $^{\circ}$ C, RH=85 $^{\circ}$ , Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 $^{\circ}$ C to 125 $^{\circ}$ C , 500 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)  JEITA +/-1000V,1time		0/3	Class: Equivalent to C2b	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3

#### Note:

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>•</sup>It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

### •Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T (FIT)$$

①Unique failure rate (λb)

$$\lambda b = 0.03 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term ( $\pi$ T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV) Ta: Ambient temperature ( $^{\circ}$ C)

πΤsim	$\pi$ T simplified chart as Ea=0.7 eV											
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

# ·MTTF ( Mean Time To Failure )

$$MTTF = 1/\lambda$$



### Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

<sup>\*1.</sup> First four digit

#### Table. Product list

No	Group	Product part number	Package code	No	Group	Product part number	Package code
	RX62N	R5F562N7ADBG	PLBG0176G*	51		1 2 2 2 2	<u> </u>
)	RX62N	R5F562N7ANBG	PLBG0176G*	52			
}	RX62N	R5F562N7BDBG	PLBG0176G*	53			
	RX62N	R5F562N7BNBG	PLBG0176G*	54			
,	RX62N	R5F562N8ADBG	PLBG0176G*	55			
,	RX62N	R5F562N8ANBG	PLBG0176G*	56			
,	RX62N	R5F562N8BDBG	PLBG0176G*	57			
3	RX62N	R5F562N8BNBG	PLBG0176G*	58			
)	RX62N	R5F562N7ADFB	PLQP0144K*	59			
.0	RX62N	R5F562N7ANFB	PLQP0144K*	60			
.1	RX62N	R5F562N7BDFB	PLQP0144K*	61			
2	RX62N	R5F562N7BNFB	PLQP0144K*	62			
.3	RX62N	R5F562N8ADFB	PLQP0144K*	63			
4	RX62N	R5F562N8ANFB	PLQP0144K*	64			
.5	RX62N	R5F562N8BDFB	PLQP0144K*	65			
.6	RX62N	R5F562N8BNFB	PLQP0144K*	66			
.7	RX62N	R5F562N7ADFP	PLQP0100K*	67			
.8	RX62N	R5F562N7ANFP	PLQP0100K*	68			
.9	RX62N	R5F562N7BDFP	PLQP0100K*	69			
20	RX62N	R5F562N7BNFP	PLQP0100K*	70	+		
21	RX62N	R5F562N8ADFP	PLQP0100K*	71	+		
2	RX62N	R5F562N8ANFP	PLQP0100K*	72	+		
3	RX62N	R5F562N8BDFP	PLQP0100K*	73	+		
:4	RX62N	R5F562N8BNFP	PLQP0100K*	74	+		
25	RX62N	R5F562N7ADLE	PTLG0145J*	75	+		
26	RX62N	R5F562N7ANLE	PTLG0145J*	76	+		
27	RX62N	R5F562N7BDLE	PTLG0145J*	77	+		
28	RX62N	R5F562N7BNLE	PTLG0145J*	78	+		
29	RX62N	R5F562N8ADLE	PTLG0145J*	79	+		
30	RX62N	R5F562N8ANLE	PTLG0145J*	80	+		
31	RX62N	R5F562N8BDLE	PTLG0145J*	81	+		
32	RX62N	R5F562N8BNLE	PTLG0145J*	82	+		
33	10(02)	NSI SOZIVOBIVEE	1 12001 133	83	+		
34	†		†	84	1		1
35	†		†	85	1		1
36			1	86	1		
87			1	87	1		
88			1	88	1		
89			1	89	1		
10			1	90	1		
1	†		†	91	1		1
12	+		1	92	+		+
3	+			93	+		
4	+		+	94	+		
15	+		+	95	+		
			1	96	+		
l6 l7	+		+	96	+		
17 18	+		+		+		
10	_		1	98	+		+
19 50			1	99 100	1		